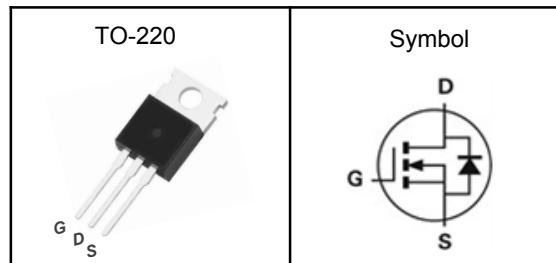


## N-Channel Enhancement Mode MOSFET

### Features

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant
- 100% UIS and Rg Tested

### Pin Description



### Applications

- Power Management in Desktop Computer
- DC/DC Converters

$V_{DSS}$	60	V
$R_{DS(ON)-Typ}$	7.5	$\text{m}\Omega$
$I_D$	65	A

### Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ , Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit
$V_{DSS}$	Drain-Source Voltage	60	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	V
$T_J$	Maximum Junction Temperature	-55 to 150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
EAS	Single Pulse Avalanche Energy <sup>③</sup>	90	mJ
$I_{DM}^{①}$	Pulse Drain Current Tested	204	A
$I_D$	Continuous Drain Current	$T_c=25^\circ\text{C}$	A
$P_D$	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	W

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	62	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction-Case <sub>1</sub>	1.56	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature  $150^\circ\text{C}$ .

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

**N-Channel Enhancement Mode MOSFET**
**Electrical Characteristics (T<sub>J</sub>=25°C, Unless Otherwise Noted)**

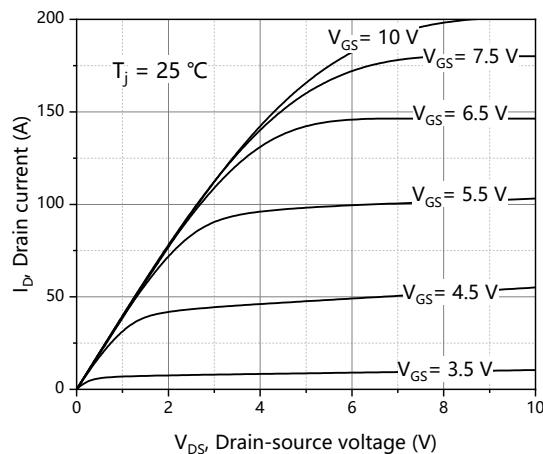
Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>Static Electrical Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	60	---	---	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V	---	---	1	uA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	1.0	---	2.5	V
I <sub>GSS</sub>	Gate Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	---	---	±100	nA
R <sub>DS(ON)</sub>	Drain-Source On-state Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	---	7.5	10	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A	---	10	14	mΩ
<b>Dynamic Characteristics<sup>⑤</sup></b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =50V, V <sub>GS</sub> =0V, Freq.=1MHz	---	1280	---	pF
C <sub>oss</sub>	Output Capacitance		---	194	---	
C <sub>rss</sub>	Reverse Transfer Capacitance		---	10	---	
T <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DS</sub> =50V, V <sub>GS</sub> =10V , I <sub>D</sub> =25A, R <sub>G</sub> =2Ω	---	23.9	---	nS
T <sub>r</sub>	Turn-on Rise Time		---	4.6	---	
T <sub>d(off)</sub>	Turn-off Delay Time		---	37.8	---	
T <sub>f</sub>	Turn-off Fall Time		---	4.6	---	
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =50V, V <sub>GS</sub> =10V , I <sub>D</sub> =25A	---	17.5	---	nC
Q <sub>gs</sub>	Gate-Source Charge		---	3.8	---	
Q <sub>gd</sub>	Gate-Drain Charge		---	4.2	---	
<b>Source-Drain Characteristics</b>						
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =20A, V <sub>GS</sub> =0V	---	---	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> =20A, V <sub>GS</sub> =0V, dI/dt=100A/us	---	42.6	---	nS
Q <sub>rr</sub>	Reverse Recovery Charge		---	36.3	---	nC

Note ④: Pulse test (pulse width≤300us, duty cycle≤2%).

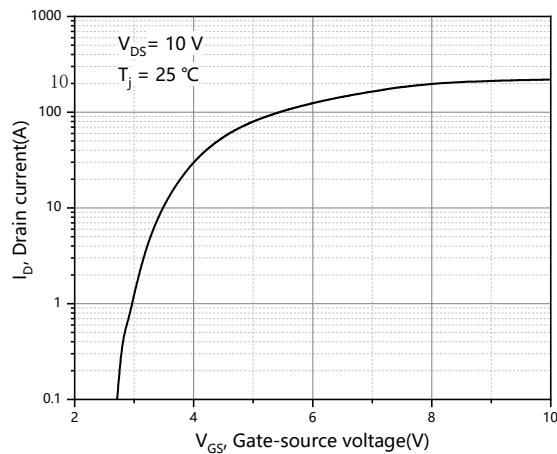
Note ⑤ : Guaranteed by design, not subject to production testing.

## N-Channel Enhancement Mode MOSFET

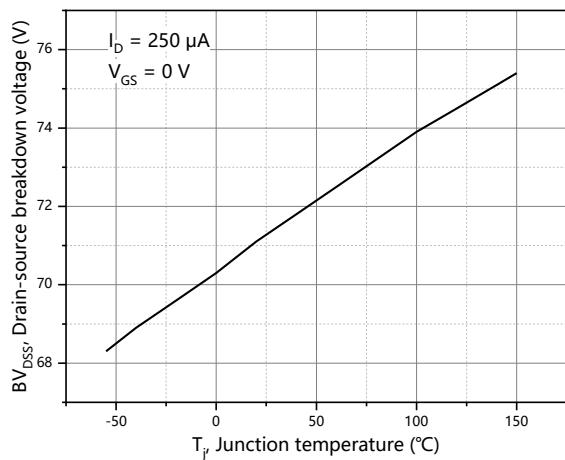
### Typical Characteristics



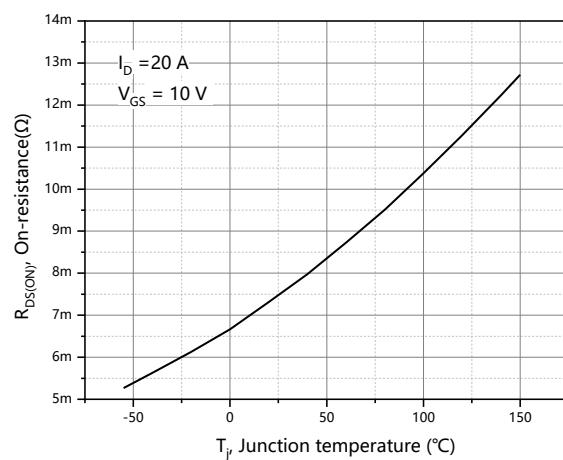
**Figure 1. Typ. output characteristics**



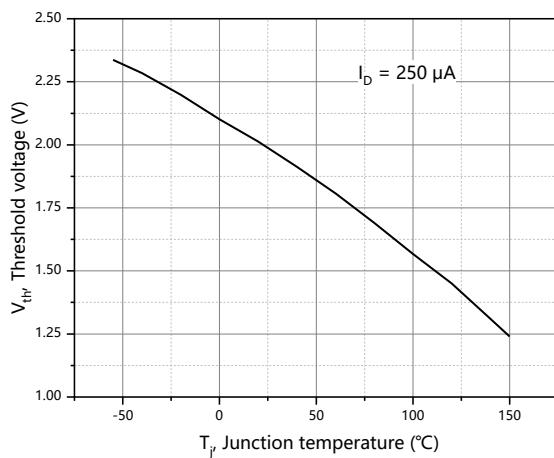
**Figure 2. Typ. transfer characteristics**



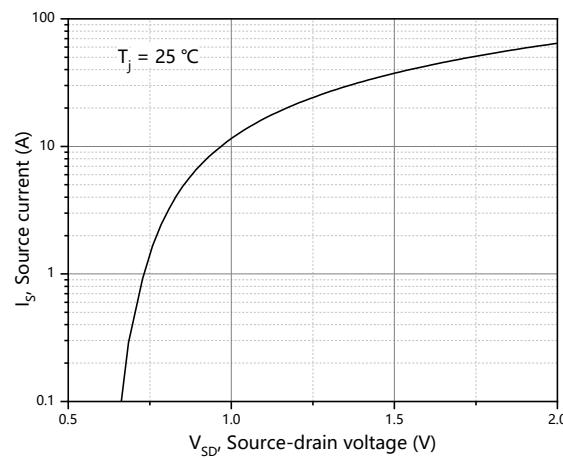
**Figure 3. Drain-source breakdown voltage**



**Figure 4. Drain-source on-state resistance**

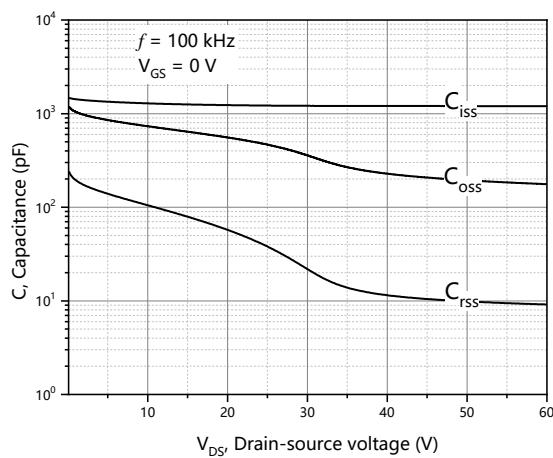


**Figure 5. Threshold voltage**

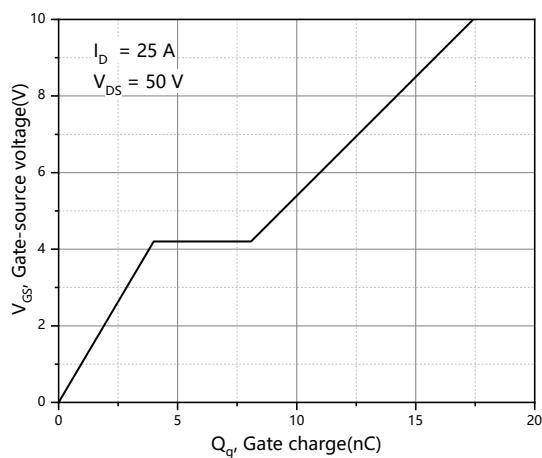


**Figure 6. Forward characteristic of body diode**

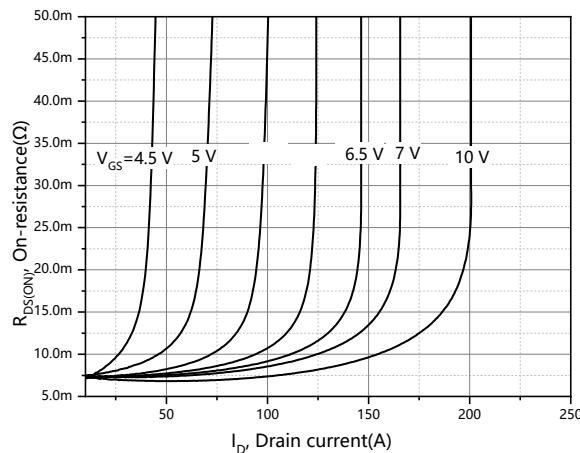
## N-Channel Enhancement Mode MOSFET



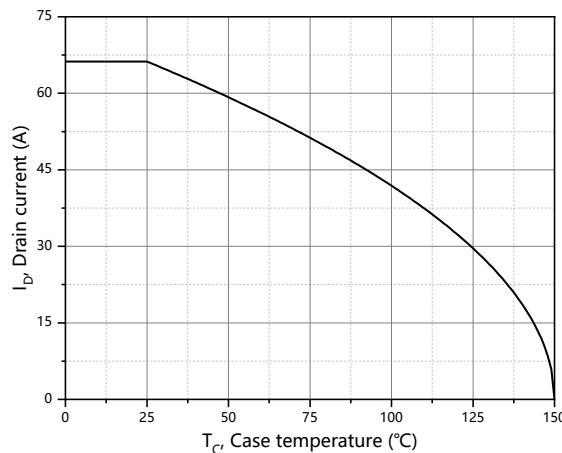
**Figure 7. Typ. capacitances**



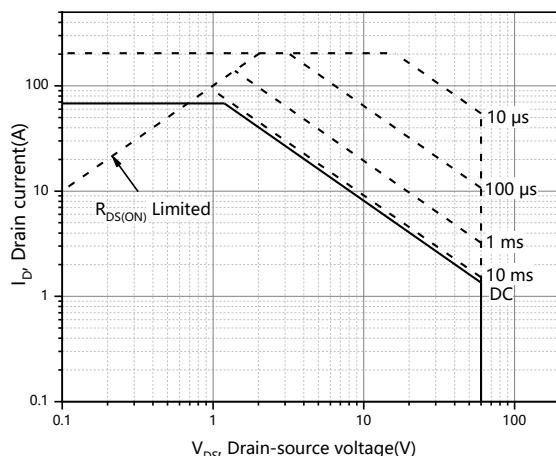
**Figure 8. Typ. gate charge**



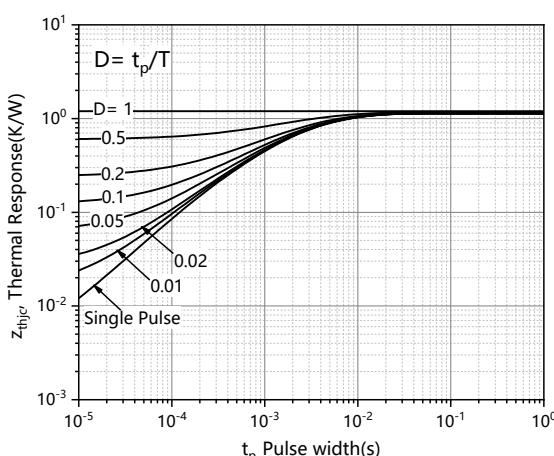
**Figure 9. Drain-source on-state resistance**



**Figure 10. Drain current**



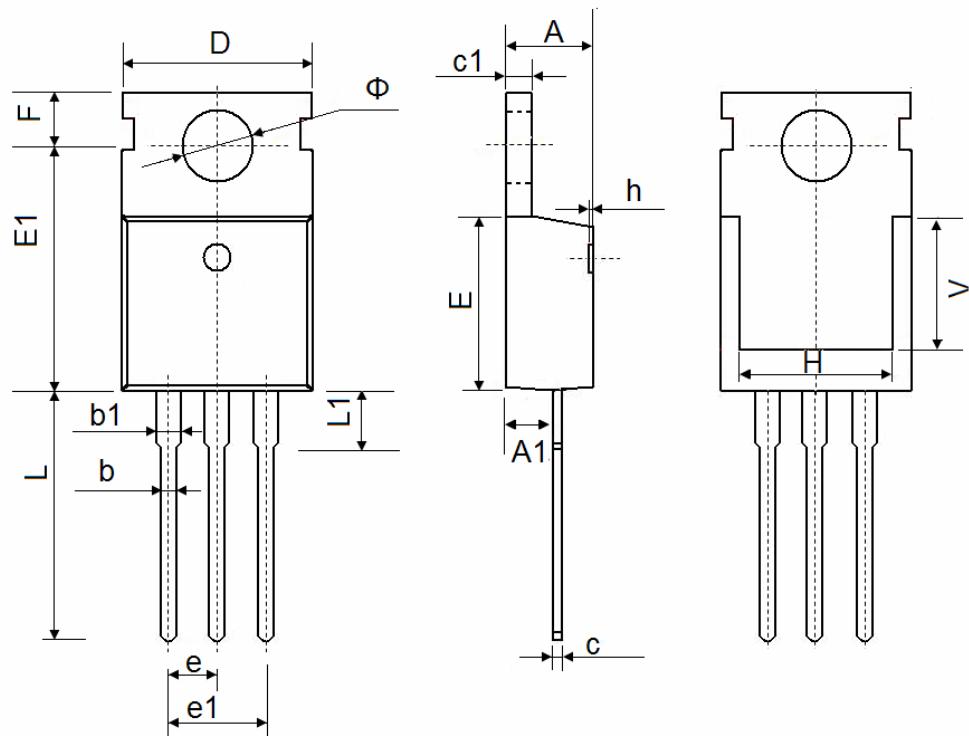
**Figure 11. Safe operation area  $T_C=25^\circ\text{C}$**



**Figure 12. Max. transient thermal impedance**

## N-Channel Enhancement Mode MOSFET

### TO-220 Package Outline Data



Symbol	Dimensions In Millimeters	
	Min.	Max.
A	4.350	4.650
A1	2.250	2.550
b	0.710	0.910
b1	1.170	1.400
c	0.330	0.650
c1	1.200	1.400
D	9.910	10.250
E	8.9500	9.750
E1	12.650	12.950
e	2.540 TYP.	
e1	4.980	5.180
F	2.650	2.950
H	7.900	8.100
h	0.000	0.300
L	12.700	13.500
L1	2.850	3.250
V	7.500 REF.	
Φ	3.400	3.800